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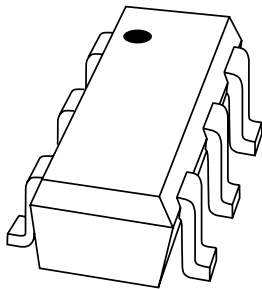
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Kind regards,

Team Nexperia

# DATA SHEET



**PBSS5240Y**

40 V low  $V_{CEsat}$  PNP transistor

Product data sheet  
Supersedes data of 2001 Oct 24

2002 Feb 28



# 40 V low $V_{CEsat}$ PNP transistor

# PBSS5240Y

### FEATURES

- Low collector-emitter saturation voltage
- High current capability
- Improved device reliability due to reduced heat generation
- Replacement for SOT89/SOT223 standard packaged transistors due to enhanced performance.

### APPLICATIONS

- Supply line switching circuits
- Battery management applications
- DC/DC converter applications
- Strobe flash units
- Heavy duty battery powered equipment (motor and lamp drivers).

### DESCRIPTION

PNP low  $V_{CEsat}$  transistor in a SOT363 (SC-88) plastic package.  
 NPN complement: PBSS4240Y.

### MARKING

TYPE NUMBER	MARKING CODE <sup>(1)</sup>
PBSS5240Y	52*

### Note

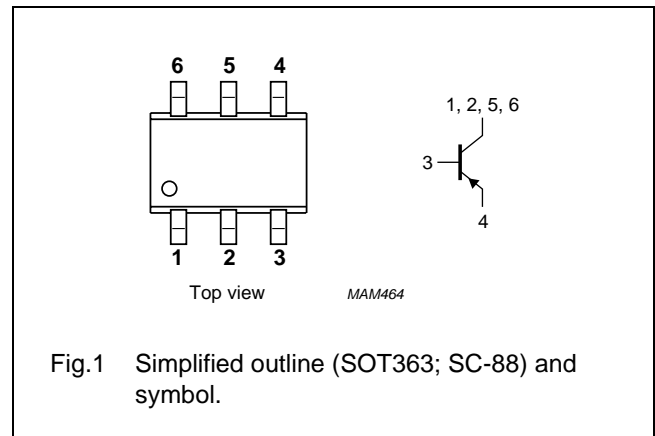
- \* = p: made in Hongkong.  
 \* = t: made in Malaysia.

### QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
$V_{CEO}$	collector-emitter voltage	-40	V
$I_{CM}$	peak collector current	-3	A
$I_C$	collector current (DC)	-2	A
$R_{CEsat}$	equivalent on-resistance	<200	mΩ

### PINNING

PIN	DESCRIPTION
1	collector
2	collector
3	base
4	emitter
5	collector
6	collector



40 V low  $V_{CEsat}$  PNP transistor

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**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	–40	V
$V_{CEO}$	collector-emitter voltage	open base	–	–40	V
$V_{EBO}$	emitter-base voltage	open collector	–	–5	V
$I_C$	collector current (DC)		–	–2	A
$I_{CM}$	peak collector current		–	–3	A
$I_{BM}$	peak base current		–	–300	mA
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$ ; note 1	–	270	mW
		$T_{amb} \leq 25\text{ °C}$ ; note 2	–	430	mW
$T_{stg}$	storage temperature		–65	+150	°C
$T_j$	junction temperature		–	150	°C
$T_{amb}$	operating ambient temperature		–65	+150	°C

**Notes**

1. Device mounted on a printed-circuit board, single side copper, tinplated and standard footprint.
2. Device mounted on a printed-circuit board, single side copper, tinplated and mounting pad for collector 1 cm<sup>2</sup>.

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	463	K/W
		note 2	291	K/W

**Notes**

1. Device mounted on a printed-circuit board, single side copper, tinplated and standard footprint.
2. Device mounted on a printed-circuit board, single side copper, tinplated and mounting pad for collector 1 cm<sup>2</sup>.

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**CHARACTERISTICS** $T_{amb} = 25\text{ °C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -30\text{ V}; I_E = 0$	–	–100	nA
		$V_{CB} = -30\text{ V}; I_E = 0; T_j = 150\text{ °C}$	–	–50	$\mu\text{A}$
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = -4\text{ V}; I_C = 0$	–	–100	nA
$h_{FE}$	DC current gain	$V_{CE} = -2\text{ V}; I_C = -100\text{ mA}$	300	–	
		$V_{CE} = -2\text{ V}; I_C = -500\text{ mA}$	260	–	
		$V_{CE} = -2\text{ V}; I_C = -1000\text{ mA}$	210	–	
		$V_{CE} = -2\text{ V}; I_C = -2000\text{ mA}$	100	–	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -100\text{ mA}; I_B = -1\text{ mA}$	–	–100	mV
		$I_C = -500\text{ mA}; I_B = -50\text{ mA}$	–	–110	mV
		$I_C = -750\text{ mA}; I_B = -15\text{ mA}$	–	–225	mV
		$I_C = -1000\text{ mA}; I_B = -50\text{ mA}$	–	–225	mV
		$I_C = -2000\text{ mA}; I_B = -200\text{ mA}$	–	–350	mV
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -2000\text{ mA}; I_B = -200\text{ mA}$	–	–1.1	V
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = -2\text{ V}; I_C = -100\text{ mA}$	–	–0.75	V
$C_c$	collector capacitance	$V_{CB} = -10\text{ V}; I_E = I_e = 0; f = 1\text{ MHz}$	–	40	pF
$F_T$	transition frequency	$I_C = -100\text{ mA}; V_{CE} = -10\text{ V}; f = 100\text{ MHz}$	100	–	MHz

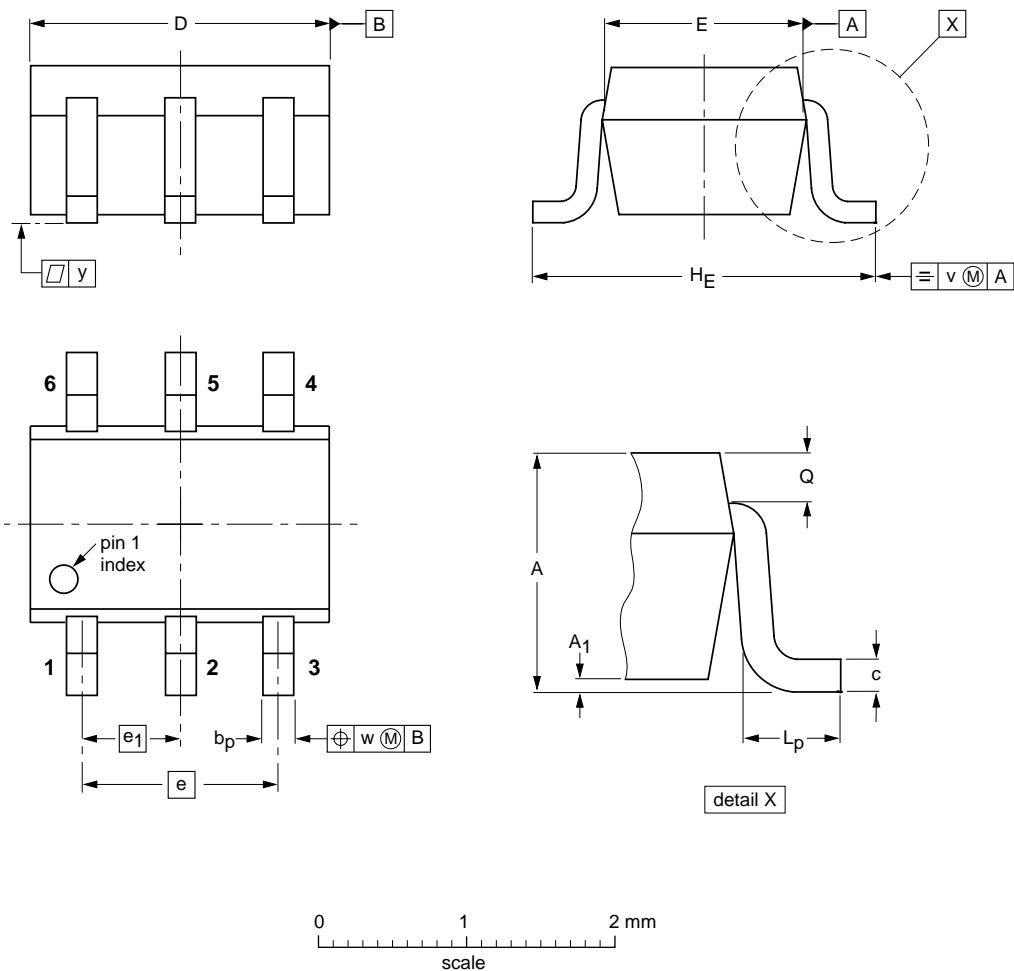
40 V low  $V_{CEsat}$  PNP transistor

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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT363



DIMENSIONS (mm are the original dimensions)

UNIT	A	A <sub>1</sub> max	b <sub>p</sub>	c	D	E	e	e <sub>1</sub>	H <sub>E</sub>	L <sub>p</sub>	Q	v	w	y
mm	1.1 0.8	0.1	0.30 0.20	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.25 0.15	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT363			SC-88			97-02-28

40 V low  $V_{CEsat}$  PNP transistor

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**DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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# ***NXP Semiconductors***

## **Customer notification**

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## **Contact information**

For additional information please visit: **<http://www.nxp.com>**

For sales offices addresses send e-mail to: **[salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)**

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